Preface

The 5th Asian Symposium on Materials and Processing (ASMP2018) was held in Swissôtel Le Concorde, Bangkok, Thailand from December 7th to 8th, 2018, as an international activity of the Materials and Processing (M&P) division of JSME. The aim of the symposium is to enhance mutual collaboration for higher research level and activity in the fields of Materials and Processing Engineering in Asian region. The symposium was a great success, and 3 keynote speech, 93 oral presentations and 24 poster presentations were made from Japan, Thailand, India and Malaysia.

This special issue “Recent Advances in Materials and Processing 2018” contains 16 papers, which are presented at the symposium and accepted after a strict peer review process by the editorial committee. The members of the editorial committee for this special issue are:

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On behalf of the editorial committee, I would like to express my sincere thanks to the reviewers as well as all committee members of ASMP2018.

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